

## Typical Application Circuit

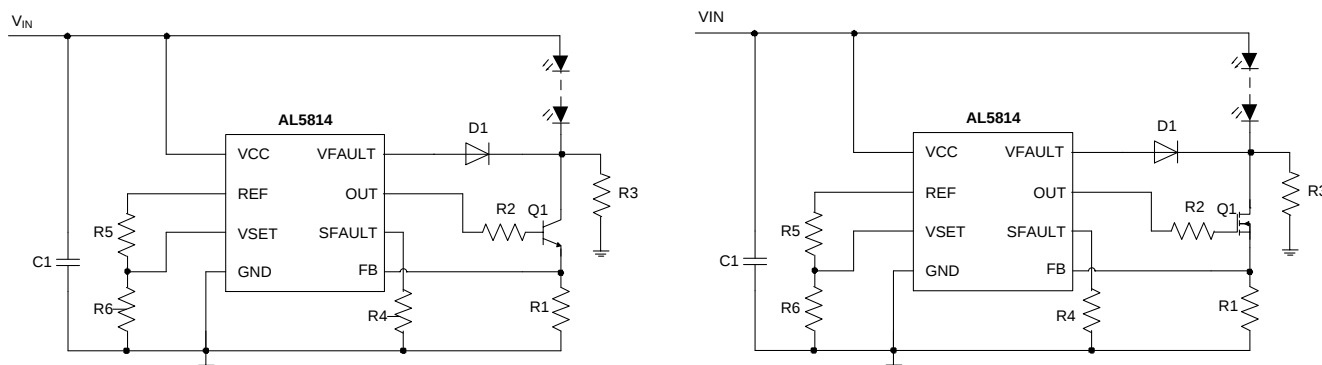


Figure 1

## Pin Descriptions

| Pin Number | Pin Name | Function                                                                                                                                                                                                                                                                                                                                        |
|------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1          | VCC      | Supply input                                                                                                                                                                                                                                                                                                                                    |
| 2          | REF      | Internal reference voltage.<br>The maximum recommended output current is 50μA and the maximum recommended capacitor connected from this pin to GND is less than 100pF.<br>A potential divider from REF to VSET can be used to accurately set the output LED current.                                                                            |
| 3          | VSET     | LED current setting threshold.<br>The voltage on VSET sets the reference voltage for the FB pin. This pin is pulled down internally if left floating. The capacitance if needed between VSET and GND is recommended to be less than 1nF.                                                                                                        |
| 4          | GND      | Ground                                                                                                                                                                                                                                                                                                                                          |
| 5          | FB       | Feedback input.<br>When control loop is operating in linear mode, the FB pin will be regulated to the level set by VSET. This pin is pulled up internally if left floating.<br>A capacitor may be added between FB and GND to improve noise rejection. Value needs to be limited to 100pF or less.                                              |
| 6          | SFAULT   | VCC enable level setting for LED-open protection activation.<br>Used in conjunction with VCC to determine<br>1. If LED-open is activated and<br>2. At what VCC voltage it becomes active<br>This function prevents false triggering on power up.                                                                                                |
| 7          | OUT      | Driving output                                                                                                                                                                                                                                                                                                                                  |
| 8          | VFAULT   | Input for LED-open detection.<br>When LED-open detection function is active, if VFAULT is brought lower than approximately 2.5V, the device output will be turned off and will auto-retry driving the output to see if the fault still exists.<br>A PWM dimming function will be realized by adding an open collector/drain signal on this pin. |
| EP         | EP       | Exposed Pad (Bottom).<br>Recommended to be connected to a large-area contiguous copper GND plane for effective thermal dissipation. Do not use as the IC's only electrical GND connection.                                                                                                                                                      |

# Functional Block Diagram

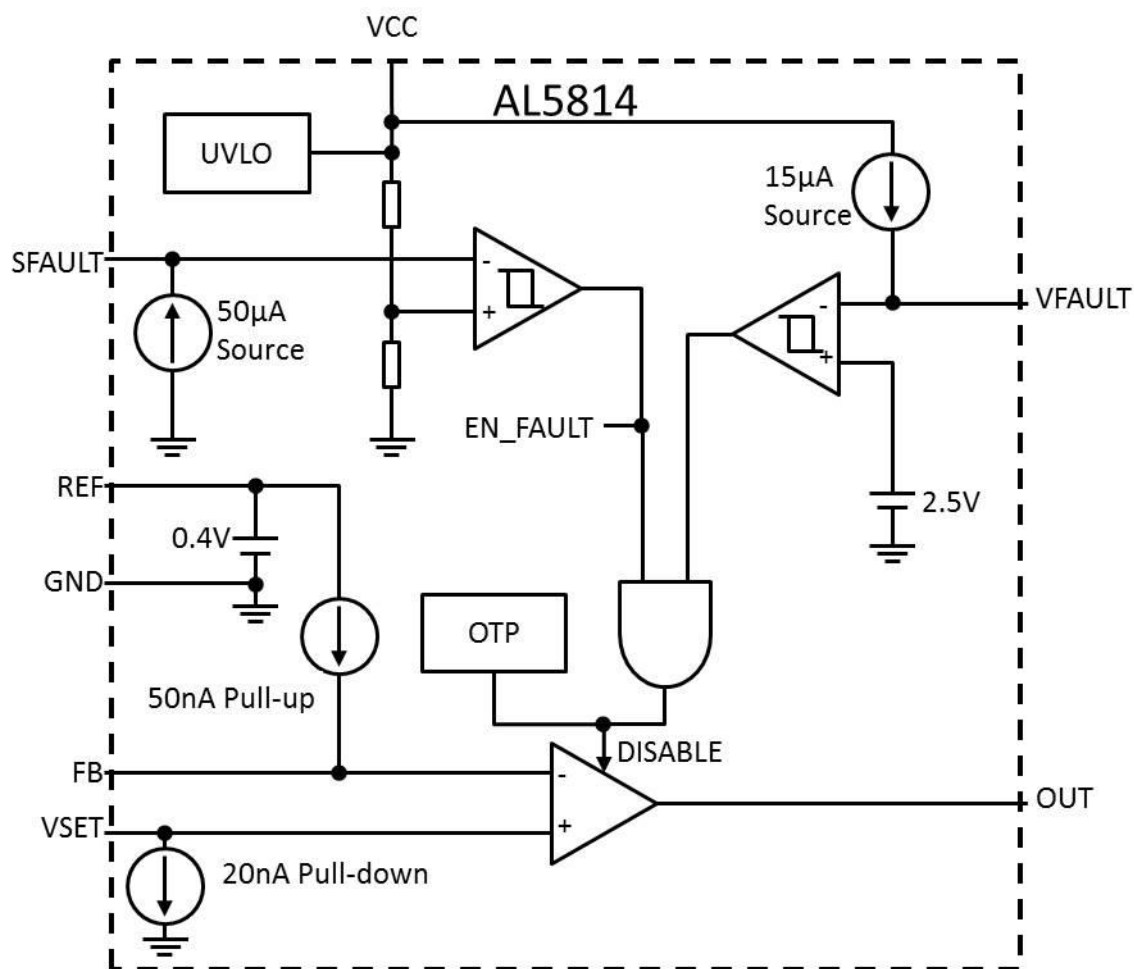


Figure 2

## Absolute Maximum Ratings (Note 4)

| Symbol                                                             | Parameter                                                   | Rating           | Unit |
|--------------------------------------------------------------------|-------------------------------------------------------------|------------------|------|
| $V_{VCC}$                                                          | Supply Voltage Relative to GND                              | -0.3 to 65       | V    |
| $I_{VCC}$                                                          | IC Supply Current                                           | 18               | mA   |
| $V_{VFAULT}$                                                       | Input Voltage Relative to GND                               | -0.3 to $V_{CC}$ | V    |
| $V_{REF}$ , $V_{VSET}$ ,<br>$V_{SFAULT}$ , $V_{OUT}$ ,<br>$V_{FB}$ | Input Voltage of REF, VSET, SFAULT, OUT, FB Relative to GND | -0.3 to 6        | V    |
| $T_J$                                                              | Operating Junction Temperature                              | -40 to +150      | °C   |
| $T_{ST}$                                                           | Storage Temperature                                         | -55 to +150      | °C   |

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability.

## ESD Ratings

| Symbol           | Parameter                  | Rating | Unit |
|------------------|----------------------------|--------|------|
| V <sub>ESD</sub> | Human-Body Model (HBM)     | 2000   | V    |
|                  | Charged-Device Model (CDM) | 1000   |      |

## Recommended Operating Conditions

| Symbol            | Parameter                                | Min | Max  | Unit |
|-------------------|------------------------------------------|-----|------|------|
| V <sub>VCC</sub>  | Supply Voltage Range Relative to GND Pin | 4.5 | 60   | V    |
| V <sub>OUT</sub>  | OUT Voltage Range                        | 0   | 4    | V    |
| I <sub>OUT</sub>  | OUT Pin Current                          | 0   | 15   | mA   |
| V <sub>VSET</sub> | VSET Pin Operating Input Voltage Range   | 0   | 0.6  | V    |
| T <sub>J</sub>    | Operating Junction Temperature Range     | -40 | +125 | °C   |
| T <sub>A</sub>    | Operating Ambient Temperature            | -40 | +105 | °C   |

## Thermal Information (Notes 5 and 6)

| Symbol        | Parameter                                 | Rating | Unit |
|---------------|-------------------------------------------|--------|------|
| $\theta_{JA}$ | Junction-To-Ambient Thermal Resistance    | 90     | °C/W |
| $\theta_{JC}$ | Junction-To-Case (Top) Thermal Resistance | 39     | °C/W |

Note: 5. Dominant conduction path via exposed pad.

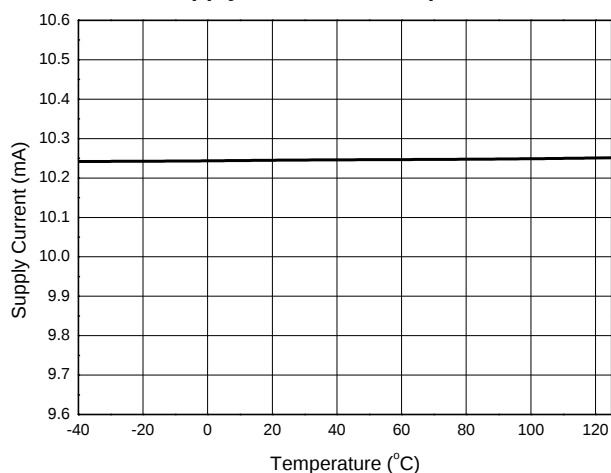
6. Test condition for MSOP-8EP: Device mounted on FR-4 PCB (51mm x 51mm 2oz copper, minimum recommended pad layout on top layer and thermal vias to bottom layer ground plane. For better thermal performance, larger copper pad for heat-sink is needed.

# Electrical Characteristics (V<sub>CC</sub> = 12V and T<sub>A</sub> = +25°C, unless otherwise specified.)

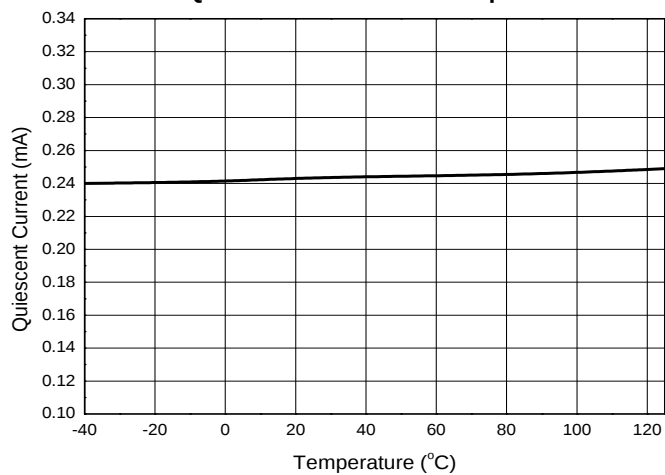
| Symbol                                | Parameter                                                           | Conditions                                                                                                                                       | Min   | Typ   | Max   | Unit |
|---------------------------------------|---------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|-------|------|
| <b>Power Supply</b>                   |                                                                     |                                                                                                                                                  |       |       |       |      |
| V <sub>UVLO</sub>                     | Under-Voltage Lock-out Voltage                                      | V <sub>IN</sub> Rising                                                                                                                           | -     | 4.2   | 4.4   | V    |
|                                       |                                                                     | V <sub>IN</sub> Falling                                                                                                                          | 3.6   | 3.85  | -     |      |
| I <sub>CC</sub>                       | Supply Current                                                      | V <sub>CC</sub> = 4.5V to 60V, I <sub>OUT</sub> = 10mA                                                                                           | -     | 10.25 | 11    | mA   |
| I <sub>Q</sub>                        | No Load Quiescent Current                                           | V <sub>CC</sub> = 4.5V to 60V, I <sub>OUT</sub> = 0                                                                                              | -     | 0.25  | 1     | mA   |
| <b>Reference and Feedback Loop</b>    |                                                                     |                                                                                                                                                  |       |       |       |      |
| V <sub>REF</sub>                      | Reference Voltage                                                   | V <sub>CC</sub> = 4.5V to 60V, I <sub>OUT</sub> = 0, I <sub>REF</sub> = 20μA                                                                     | 0.384 | 0.4   | 0.416 | V    |
| V <sub>REF_LINE</sub>                 | Reference Voltage Line Regulation                                   | V <sub>CC</sub> = 4.5V to 19V                                                                                                                    | -     | 0.2   | 3     | mV   |
| V <sub>REF_LOAD</sub>                 | Reference Voltage Load Regulation                                   | I <sub>REF</sub> = 0 to -50μA                                                                                                                    | -     | 1.4   | 6     | mV   |
| I <sub>FB</sub>                       | FB Input Bias Current                                               | V <sub>FB</sub> = 0.2V                                                                                                                           | -200  | -125  | -80   | nA   |
| I <sub>SET</sub>                      | SET Input Bias Current                                              | V <sub>SET</sub> = 0.6V                                                                                                                          | -     | 25    | 45    | nA   |
| V <sub>OFFSET</sub>                   | V <sub>SET</sub> to V <sub>FB</sub> Offset                          | V <sub>SET</sub> = 0.2V, V <sub>FB</sub> = V <sub>OUT</sub>                                                                                      | -     | -     | 7     | mV   |
| <b>Fault Detection and Protection</b> |                                                                     |                                                                                                                                                  |       |       |       |      |
| I <sub>SFAULT</sub>                   | Source Current from SFAULT Pin                                      | V <sub>CC</sub> = 4.5V to 60V                                                                                                                    | -56   | -50   | -43   | μA   |
| I <sub>VFAULT</sub>                   | Source Current from VFAULT Pin                                      | V <sub>CC</sub> = 4.5V to 60V                                                                                                                    | -20   | -15   | -10   | μA   |
| V <sub>VFAULT</sub>                   | VFAULT Pin Threshold Voltage                                        | V <sub>CC</sub> = 4.5V to 60V, V <sub>VFAULT</sub> Falling                                                                                       | 2.37  | 2.5   | 2.63  | V    |
| V <sub>VFAULT_HYS</sub>               | V <sub>VFAULT</sub> Hysteresis                                      | -                                                                                                                                                | -     | 100   | -     | mV   |
| t <sub>VF_OUTR</sub>                  | VFAULT to OUT Rising Delay                                          | -                                                                                                                                                | -     | 2     | -     | μs   |
| t <sub>VF_OUTF</sub>                  | VFAULT to OUT Falling Delay                                         | -                                                                                                                                                | -     | 1     | -     |      |
| T <sub>SHDN</sub>                     | Thermal Shutdown                                                    | -                                                                                                                                                | -     | +160  | -     | °C   |
| T <sub>HYS</sub>                      | Thermal Shutdown Hysteresis                                         | -                                                                                                                                                | -     | +30   | -     | °C   |
| <b>Output Driver Error Amplifier</b>  |                                                                     |                                                                                                                                                  |       |       |       |      |
| I <sub>OUTSOURCE</sub>                | Maximum Source Current<br>V <sub>SET</sub> - V <sub>FB</sub> = 10mV | V <sub>OUT</sub> = 0V, V <sub>CC</sub> = 4.5V to 60V                                                                                             | -     | -     | -15   | mA   |
|                                       |                                                                     | V <sub>OUT</sub> = 1V, V <sub>CC</sub> = 4.5V to 60V                                                                                             | -     | -     | -15   |      |
|                                       |                                                                     | V <sub>OUT</sub> = 2V, V <sub>CC</sub> = 4.5V to 60V                                                                                             | -     | -     | -11   |      |
|                                       |                                                                     | V <sub>OUT</sub> = 4V, V <sub>CC</sub> = 6.0V to 60V                                                                                             | -     | -     | -5    |      |
| I <sub>OUTSINK</sub>                  | Maximum Sink Current                                                | V <sub>CC</sub> = 12V, V <sub>OUT</sub> = 4V, V <sub>VFAULT</sub> > 2.7V,<br>V <sub>SET</sub> - V <sub>FB</sub> = -50mV                          | 20    | -     | -     | μA   |
|                                       |                                                                     | V <sub>CC</sub> = 12V, V <sub>OUT</sub> = 4V, VFAULT enabled by SFAULT<br>V <sub>SET</sub> - V <sub>FB</sub> = -50mV, V <sub>VFAULT</sub> < 2.3V | 0.3   | -     | -     | mA   |
| G <sub>m</sub>                        | Trans-Conductance of Error Amplifier                                | V <sub>SET</sub> - V <sub>FB</sub> = 5mV, Sourcing Current                                                                                       | -     | 4     | -     | A/V  |
| BW                                    | Bandwidth                                                           | -                                                                                                                                                | -     | 50    | -     | kHz  |
| V <sub>OUTMAX</sub>                   | Maximum Output Voltage                                              | V <sub>CC</sub> ≥ 6V, I <sub>OUT</sub> = -1mA                                                                                                    | 4     | -     | -     | V    |
| V <sub>OUTMIN</sub>                   | Minimum Output Voltage                                              | V <sub>CC</sub> = 12V, I <sub>OUT</sub> = 0.1mA, V <sub>FB</sub> = 250mV                                                                         | -     | -     | 300   | mV   |

**Typical Performance Characteristics** ( $V_{CC} = 12V$ ,  $T_A = +25^\circ C$ , unless otherwise specified.)

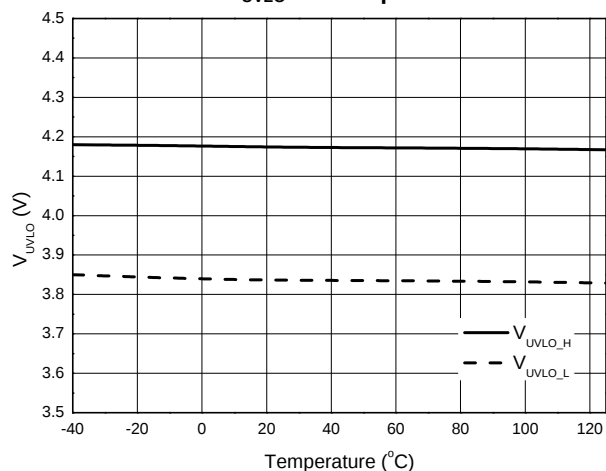
**Supply Current vs. Temperature**



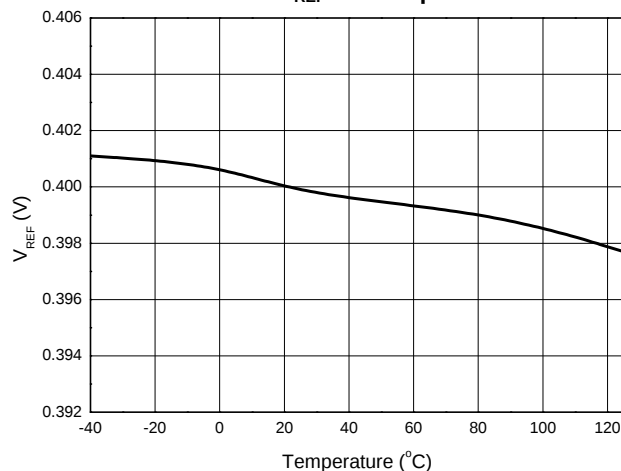
**Quiescent Current vs. Temperature**



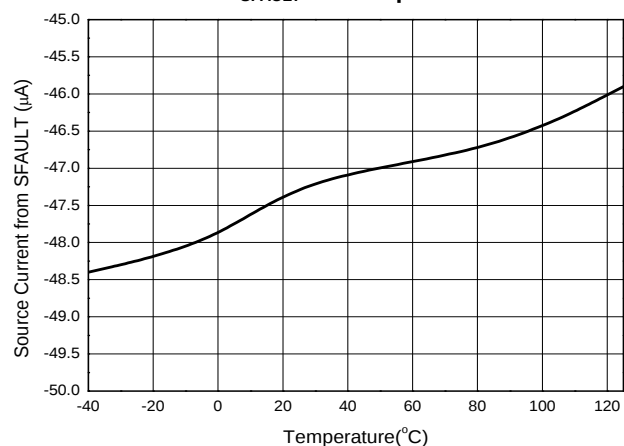
**$V_{UVLO}$  vs. Temperature**



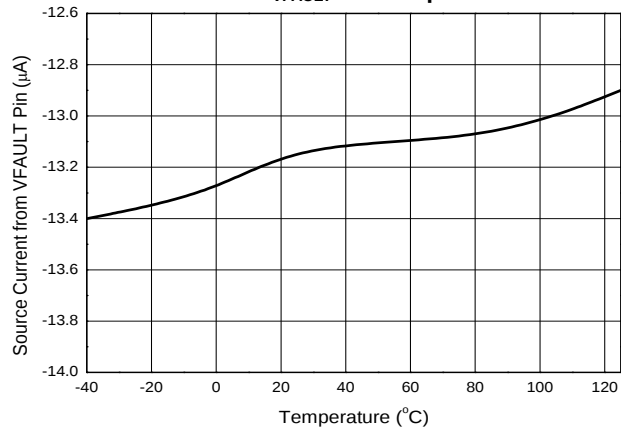
**$V_{REF}$  vs. Temperature**



**$I_{SFAULT}$  vs. Temperature**

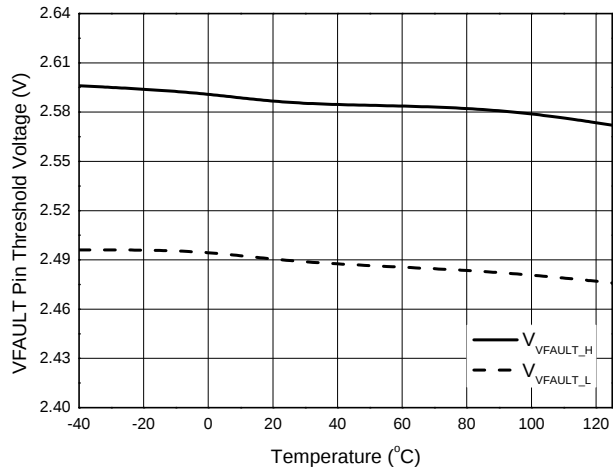


**$I_{VFAULT}$  vs. Temperature**

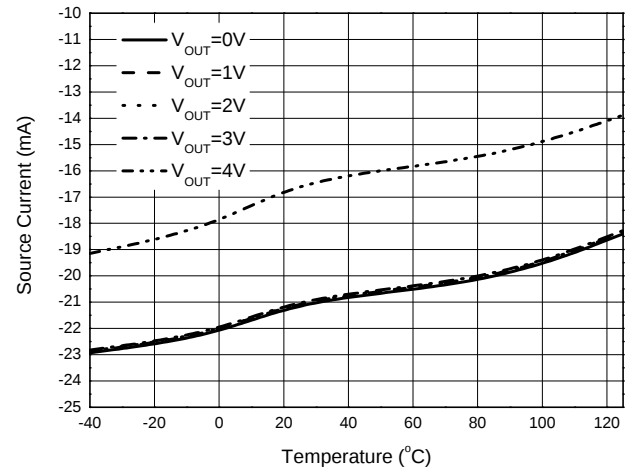


**Typical Performance Characteristics** (Cont.) ( $V_{CC} = 12V$ ,  $T_A = +25^\circ C$ , unless otherwise specified.)

**$V_{VFAULT}$  vs. Temperature**



**Source Current vs. Temperature**



## Application Information

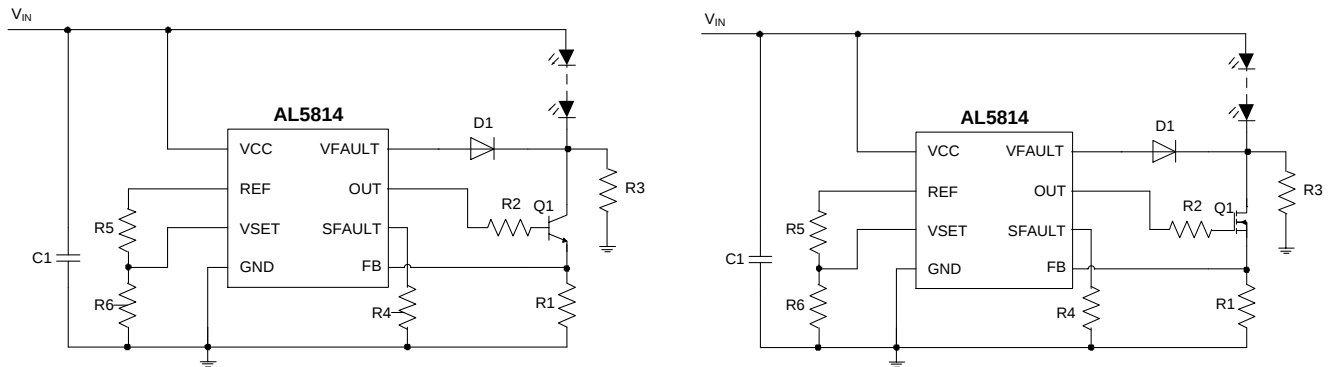


Figure 3. Typical Application

### Output Drive

Figure 3 shows the typical output drive configuration. The feedback loop regulates the current through the external LEDs. The voltage across the external sense resistor ( $R_1$ ) is fed to the FB pin for sensing. When the voltage exceeds  $V_{SET}$  voltage the OUT goes lower, decreasing the drive to the external transistor.

The output current can be set as following:

$$I_{LED} = \frac{V_{VSET}}{R_1} \quad (1)$$

Where  $I_{LED}$  is the desired LED current,  $V_{VSET}$  is determined by  $R_5$  and  $R_6$  resistor divider and  $R_1$  is the sense resistor.

The power in the sense resistor is calculated as:

$$Power = V_{VSET} * I_{LED}$$

Where  $V_{VSET} = V_{SET}$  voltage and  $I_{LED}$  is the desired LED string current. For most cases, a standard 1/4W resistor will work. Similarly, the external transistor's power dissipation also must be considered to prevent thermal damage to the transistor, which can further damage the LED controller IC.

### Power Consideration of the NMOS or BJT Device

The power rating of the transistor (either BJT or NMOS) used in the typical application circuit is important. A correctly mounted transistor used in a typical application can dissipate power of up to 2 W. To calculate power dissipation, first calculate the voltage drop across the transistor as follows:

$$V_{DS} = V_{CC} - V_{LED} - V_{VSET}$$

Then calculate the power dissipation requirement:

$$Power = V_{DS} * I_{LED}$$

If power dissipation is higher than the transistor package and layout can dissipate then a higher power dissipation transistor must be selected and/or use a better PCB layout.

### Multiple LED Strings in Parallel

The AL5814 can drive more than one channel of LED strings. As shown in Figure 4, the sense voltage of two channels' (or more) output current can be implemented by connecting the voltage of one sense resistor to the FB pin.

By utilizing the same type transistors, sense resistors and series base resistors, the currents in all channels will match.

## Application Information (Cont.)

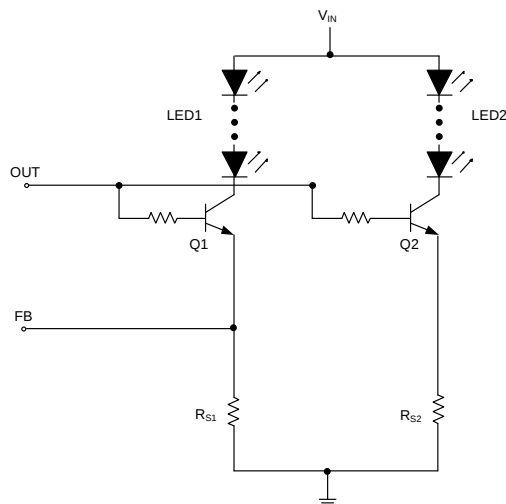


Figure 4. Two LED Strings in Parallel

The output current can be set as following:  $I_{LED1} = I_{LED2} = \dots = V_{FB}/R_{S1}$

Where  $I_{LEDx}$  is the desired LED current,  $V_{FB}$  is  $V_{VSET}$ , and  $R_{S1}$  is the sense resistor. To keep the LED currents as equal as possible, transistors Q1 and Q2 should be matched, and  $R_{S1}$  and  $R_{S2}$  should be matched.

### Open Load Detection

#### SFAULT Setup:

The AL5814 can be configured to detect the presence of the LEDs on the external output transistor going open circuit. This function is activated by the SFAULT pin. A 50μA current source from SFAULT creates a voltage ( $V_{SFAULT}$ ) across an external resistor (R7) which is compared to potential divided down VCC voltage see Figure 5 (blue components are internal to the AL5814).

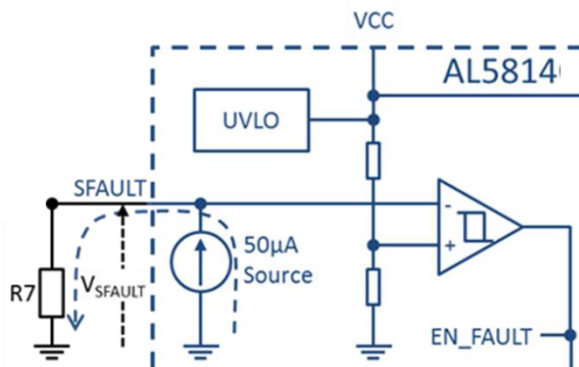


Figure 5. SFAULT Configuration

Once  $V_{CC}$  has risen to above the set voltage on the VSFAULT pin the EN\_FAULT becomes high and LED-open detection becomes functional. This avoids false triggering of open load protection during start up and power down procedure.

Supply voltage at which LED-open detection become operational is set by the following equation:

$$V_{CC} = 11 \times 50 \times 10^{-6} \times R7$$

The table below shows some approximate supply voltages that the LED-open detection becomes active by different resistor values.

| V <sub>CC</sub> (V) | R7 (kΩ) |
|---------------------|---------|
| 5.01                | 9.1     |
| 5.50                | 10      |
| 6.60                | 12      |
| 8.25                | 15      |
| 9.90                | 18      |
| 11.55               | 21      |

VFAULT

The diagram shows a precision current source circuit. An operational amplifier (op-amp) is configured with a non-inverting input (+) connected to a 2.5V reference voltage and a feedback loop from the MOSFET's drain. The op-amp's output drives the gate of an N-channel MOSFET (Q1). The MOSFET's source is connected to ground through resistor R1. The drain is connected to a load (represented by a battery symbol) through resistor R2. A diode D1 is connected between the op-amp's output and the MOSFET's gate. Resistor R3 is connected between the MOSFET's gate and drain. Resistor R4 is connected between the MOSFET's source and gate. Resistor R7 is connected between the op-amp's inverting input (-) and ground. A 15μA current source is connected to the non-inverting input (+) of the op-amp. The MOSFET's drain is also connected to a load (represented by a battery symbol) through resistor R2. A diode D1 is connected between the op-amp's output and the MOSFET's gate. Resistor R3 is connected between the MOSFET's gate and drain. Resistor R4 is connected between the MOSFET's source and gate. Resistor R7 is connected between the op-amp's inverting input (-) and ground. A 15μA current source is connected to the non-inverting input (+) of the op-amp.

Figure 6. LED-Open Detection Using VFAULT

If the LED string becomes open, VFAULT pin will be pulled down by the power bipolar or MOSFET below its internal 2.5V threshold. This condition triggers an output disable condition causing OUT to go low, turning off the external MOSFET/BJT. A resistor (R3, 100K) is needed to keep the VFAULT signal low during a fault condition. A 100k $\Omega$  will keep this node low. When the fault condition is fixed and VFAULT pin rises above 2.63V the device will operate normally.

## Feedback Loop

The device has internal compensation and therefore it is not recommended that any components are added to the feedback loop.

## LED Thermal Compensation

The LED current is set by the reference voltage at the emitter/drain voltage of the LED driving transistor. This reference voltage is determined by the resistor divider between REF and VSET. The LED driver's LED current behavior under different ambient or LED temperatures can be configured by using NTC for R6 shown in Figure 7.

## Application Information (Cont.)

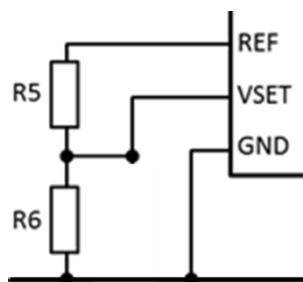


Figure 7

In the example shown in

Figure 8, the resistor network is comprised of one NTC and a resistor. When the temperature of the detecting point is rising, the NTC resistance will decrease and make the voltage at VSET decrease also, consequentially, the output current will decrease to prevent the system from over-heated.

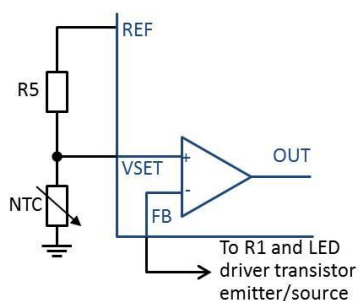
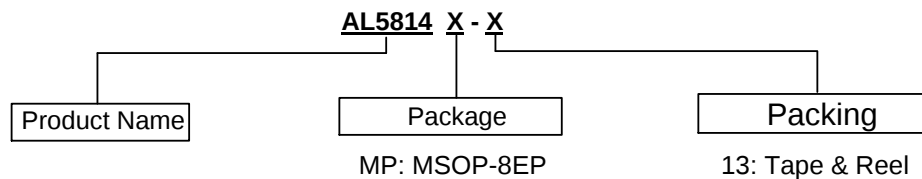


Figure 8. Thermal Fold Back Circuit Basing on NTC

### Thermal Protection

The AL5814 has an internal Over Temperature Protection (OTP). When the junction temperature is over +160°C, the IC will shut down. When the junction temperature drops by +30°C the IC turn back on.

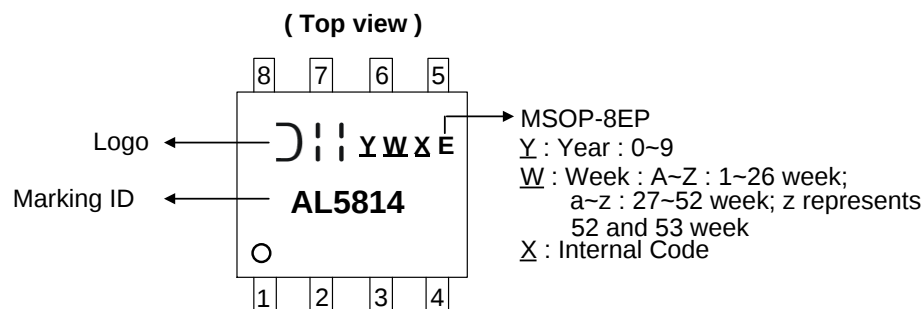
## Ordering Information (Note 7)



| Part Number | Package Code | Packaging | 13" Tape and Reel |                    |
|-------------|--------------|-----------|-------------------|--------------------|
|             |              |           | Quantity          | Part Number Suffix |
| AL5814MP-13 | MP           | MSOP-8EP  | 2500              | -13                |

Note: 7. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

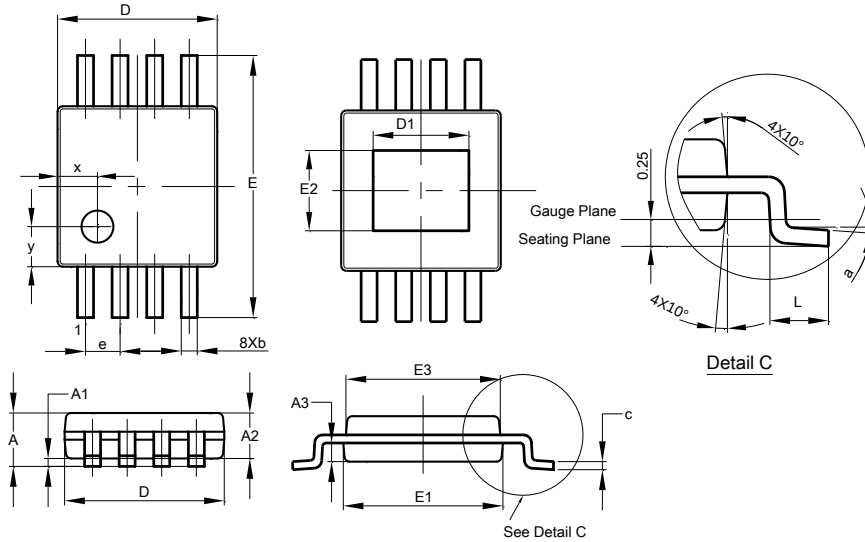


| Device      | Package  |
|-------------|----------|
| AL5814MP-13 | MSOP-8EP |

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### MSOP-8EP

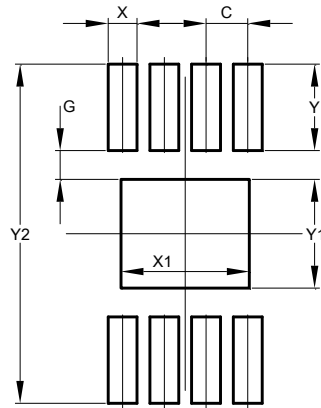


| MSOP-8EP             |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | -    | 1.10 | -     |
| A1                   | 0.05 | 0.15 | 0.10  |
| A2                   | 0.75 | 0.95 | 0.86  |
| A3                   | 0.29 | 0.49 | 0.39  |
| b                    | 0.22 | 0.38 | 0.30  |
| c                    | 0.08 | 0.23 | 0.15  |
| D                    | 2.90 | 3.10 | 3.00  |
| D1                   | 1.60 | 2.00 | 1.80  |
| E                    | 4.70 | 5.10 | 4.90  |
| E1                   | 2.90 | 3.10 | 3.00  |
| E2                   | 1.30 | 1.70 | 1.50  |
| E3                   | 2.85 | 3.05 | 2.95  |
| e                    | -    | -    | 0.65  |
| L                    | 0.40 | 0.80 | 0.60  |
| a                    | 0°   | 8°   | 4°    |
| x                    | -    | -    | 0.750 |
| y                    | -    | -    | 0.750 |
| All Dimensions in mm |      |      |       |

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### MSOP-8EP



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.650         |
| G          | 0.450         |
| X          | 0.450         |
| X1         | 2.000         |
| Y          | 1.350         |
| Y1         | 1.700         |
| Y2         | 5.300         |

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2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

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